

# PLCDA03C-6 thru PLCDA15C-6

# LOW CAPACITANCE TVS ARRAY

# APPLICATIONS

- ✔ Ethernet 10/100 Base T
- ✓ FireWire
- SCSI
- ✓ Bluetooth & RF

# IEC COMPATIBILITY (EN61000-4)

✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
✓ 61000-4-4 (EFT): 40A - 5/50ns
✓ 61000-4-5 (Surge): 24A, 8/20µs - Level 2(Line-Gnd) & Level 3(Line-Line)

## FEATURES

- ✓ 500 Watts Peak Pulse Power per Line (tp=8/20µs)
- ✔ Bidirectional Configuration
- ✔ Available in 5 Voltage Types: 3.3V to 15V
- ✔ Protects Up to Six (6) Lines
- ✓ ESD Protection > 40 kilovolts
- ✔ LOW CAPACITANCE: 8pF
- ✓ RoHS Compliant in Lead-Free Versions

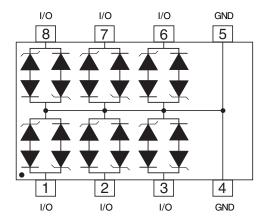
# MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SO-8 Package
- ✓ Weight 70 milligrams (Approximate)
- ✓ Available in Tin-Lead or Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:

Tin-Lead - Sn/Pb, 85/15: 240-245°C Pure-Tin - Sn, 100: 260-270°C

- ✓ Flammability Rating UL 94V-0
- ✓ 12mm Tape and Reel Per EIA Standard 481
- ✔ Marking: Logo, Marking Code, Date Code & Pin One Defined By Dot on Top of Package

# **PINCONFIGURATION**



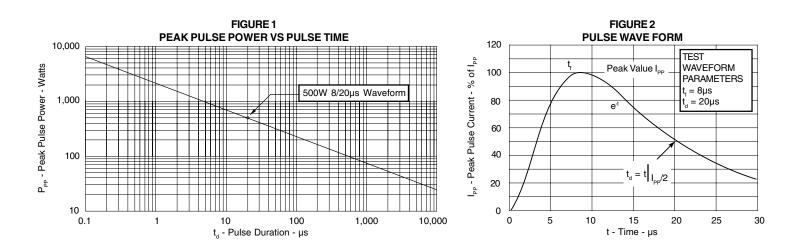


DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified						
PARAMETER	SYMBOL	VALUE	UNITS			
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	P <sub>PP</sub>	500	Watts			
Operating Temperature	Tj	-55°C to 150°C	°C			
Storage Temperature	T <sub>stg</sub>	-55°C to 150°C	℃°			

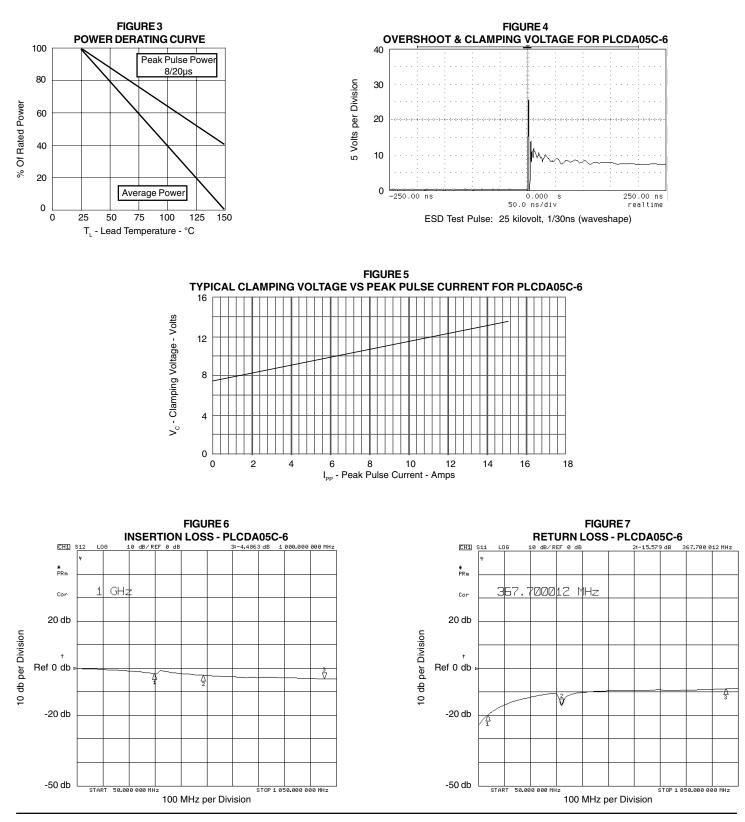
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified									
PART NUMBER	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM LEAKAGE CURRENT	TYPICAL CAPACITANCE (See Note 1)		
		V VOLTS	@ 1mA V <sub>BR)</sub> VOLTS	@ I <sub>P</sub> = 1A V <sub>C</sub> VOLTS	@8/20µs V <sub>C</sub> @ I <sub>PP</sub>	@V <sub>wm</sub> Ι <sub>D</sub> μΑ	0V @ 1 MHz C pF		
PLCDA03C-6 PLCDA05C-6 PLCDA08C-6 PLCDA12C-6	PRS PRT PRW PRV	3.3 5.0 8.0 12.0	4.5 6.0 8.5 13.3	7.0 9.8 13.4 19.0	20.0V @ 35.0A 24.0V @ 42.0A 26.0V @ 34.0A 33.0V @21.0A	125 20 10 2	8 8 8 8		
PLCDA15C-6	PRU	15.0	16.7	22.0	39.0V @ 17.0A	2	8		

Note 1: Capacitance between I/O pins and ground (pins 4 & 5) is typically 8pF. Capacitance between I/O pins is typically 4 pF.



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# GRAPHS



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# APPLICATION NOTE

The PLCDAxxC-6 Series are low capacitance, bidirectional TVS arrays that are designed to protect I/O or high speed data lines from the damaging effects of ESD or EFT. This product series has a surge capability of 500 Watts  $P_{PP}$  per line for an 8/20µs waveshape and offers ESD protection > 40kv.

#### **BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)**

Ideal for use multimode transceiver I/O lines, the PLCDAxxC-6 Series provides up to six (6) lines of protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

- ✓ Line 1 is connected to Pin 1.
- ✓ Line 2 is connected to Pin 2.
- ✓ Line 3 is connected to Pin 3.
- Line 4 is connected to Pin 8.
- ✓ Line 5 is connected to Pin 7.
- ✓ Line 6 is connected to Pin 6.
- Pins 4 and 5 are connected to Ground.

### BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 2)

The PLCDAxxC-6 Series also provides video line applications six (6) lines of protection in a common-mode configuration as depicted in Figure 2.

Circuit connectivity is as follows:

- ✓ Line 1 (Red) is connected to Pin 1.
- ✓ Line 2 (Green) is connected to Pin 2.
- ✓ Line 3 (Blue) is connected to Pin 3.
- ✓ Line 4 (VSYNC) is connected to Pin 6.
- ✓ Line 5 (HSYNC) is connected to Pin 7.
- ✓ Pins 4 and 5 are connected to Ground.

#### **CIRCUIT BOARD LAYOUT RECOMMENDATIONS**

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✔ Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1: Typical Transceiver Protection Circuit

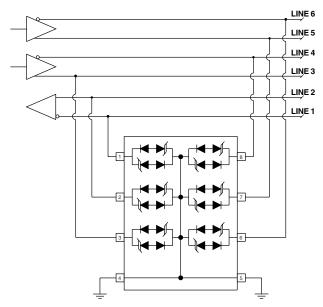
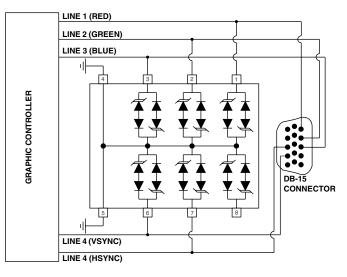


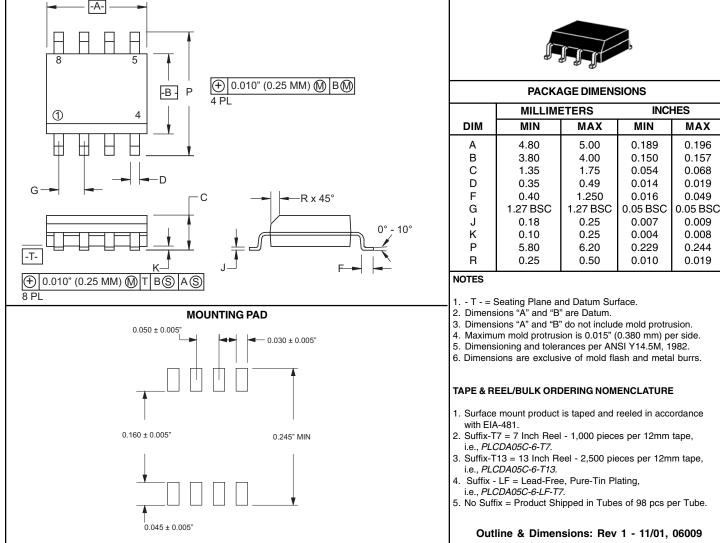
Figure 2: Typical Video Line Protection Circuit



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# PACKAGE OUTLINE & DIMENSIONS

**PACKAGE OUTLINE** 

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